

L Number	Hits	Search Text	DB	Time stamp
1	0	107103048	USPAT	2004/02/26 17:08
2	1	("6507120").PN.	USPAT	2004/02/26 17:08
3	1	("6482680").PN.	USPAT	2004/02/26 17:09
4	1	("6303997").PN.	USPAT	2004/02/26 17:09
5	1	("6208021").PN.	USPAT	2004/02/26 17:09
6	1	((("6208021").PN.) and (chip or die or package or device or surface or top or bottom or first or second or edge or encapsulant or encapsulating or plurality or bumps or ball or pad or bond or bonding or leads or lead or semiconductor))	USPAT	2004/02/26 17:13
7	1	((("6507120").PN.) and (chip or die or package or device or surface or top or bottom or first or second or edge or encapsulant or encapsulating or plurality or bumps or ball or pad or bond or bonding or leads or lead or semiconductor))	USPAT	2004/02/26 17:13
8	268	438/25	USPAT	2004/02/26 17:13
9	435	438/26	USPAT	2004/02/26 17:13
10	440	438/51	USPAT	2004/02/26 17:14
11	260	438/55	USPAT	2004/02/26 17:14
12	422	438/64	USPAT	2004/02/26 17:14
13	2219	438/106	USPAT	2004/02/26 17:14
14	588	438/111	USPAT	2004/02/26 17:14
15	804	438/112	USPAT	2004/02/26 17:14
16	733	438/122	USPAT	2004/02/26 17:14
17	1345	438/123	USPAT	2004/02/26 17:14
18	1020	438/124	USPAT	2004/02/26 17:14
19	1091	438/126	USPAT	2004/02/26 17:14
20	1319	438/127	USPAT	2004/02/26 17:14
-	0	("6700187").PN.	USPAT	2004/02/26 17:07

2/26/04